



Technical Data Sheet

TOP View LEDs (Preliminary)

67-21BSURC/S530-XX/TR8

Features

- PLCC-2 package.
- High flux output.
- High current capability.
- White package.
- Optical indicator.
- Colorless clear window.
- Ideal for backlight and light pipe application.
- Inter reflector.
- Suitable for automatic placement equipment.
- Suitable for reflow and wave solder processes.
- Available on tape and reel (12mm Tape).
- Pb-free.
- The product itself will remain within RoHS compliant version.



Descriptions

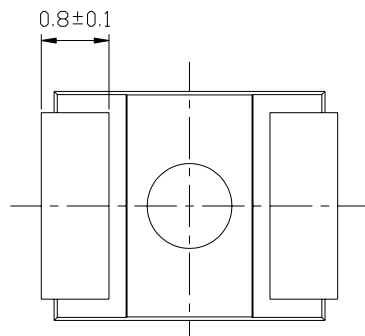
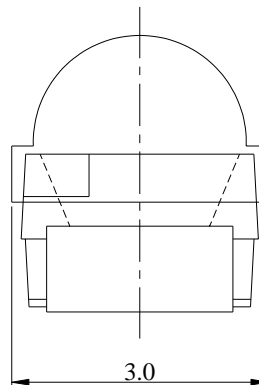
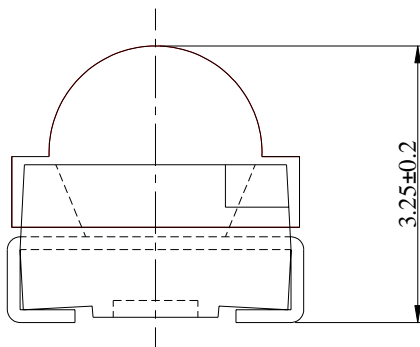
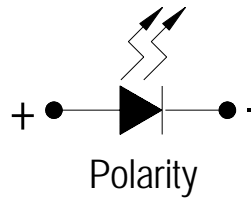
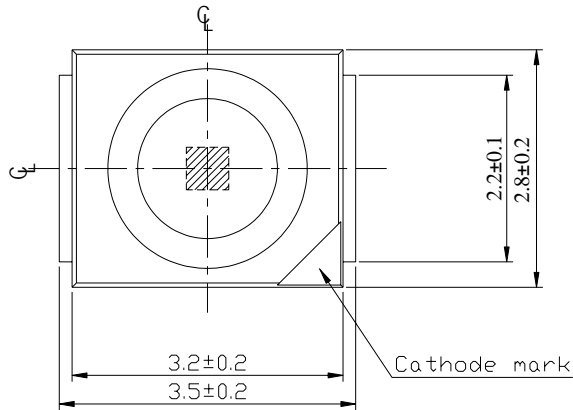
The 67-21B series is available in soft orange, red and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes the 67-21B series LED ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications

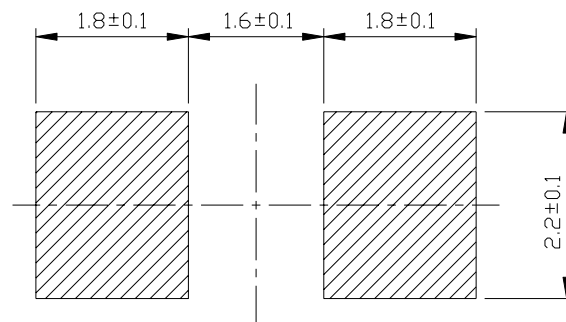
- Automotive: indoor and outdoor lighting.
- Indicator and backlight for audio and video equipment.
- Indicator and backlight in office and family equipment.
- Flat backlight for LCD's, switches and symbols.
- Light pipe application.
- General use.

Device Selection Guide

Chip		Lens Color
Material	Emitted Color	
AlGaInP	Brilliant Red	Water Clear

Package Dimensions


For reflow soldering (propose)



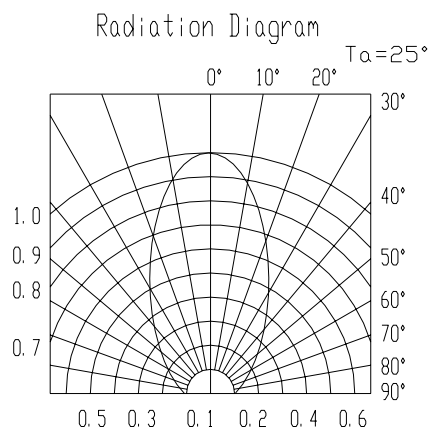
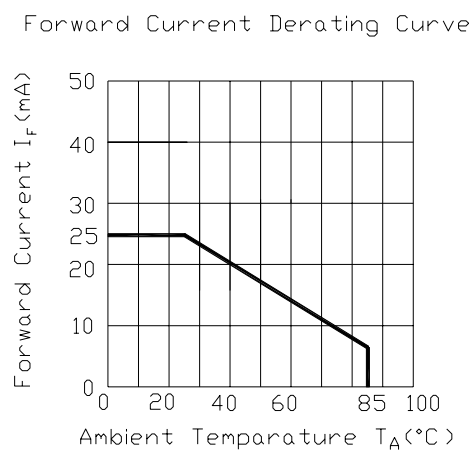
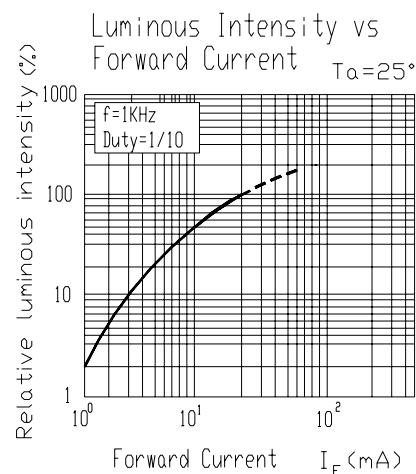
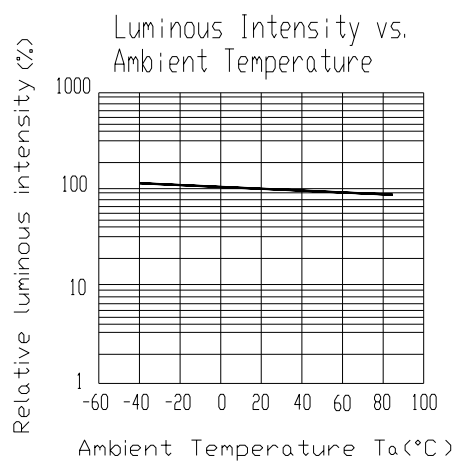
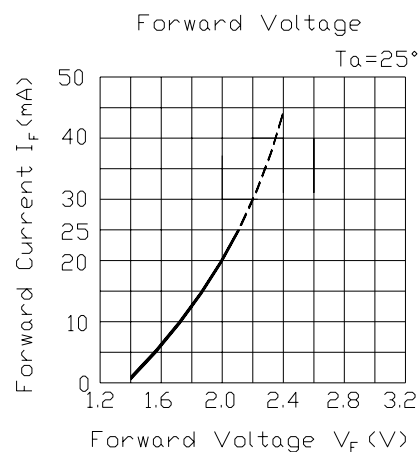
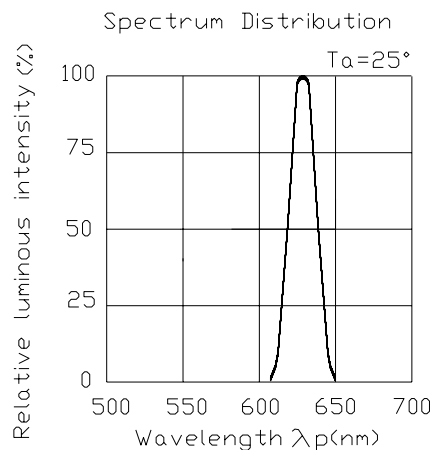
- Notes:** 1.All dimensions are in millimeters
2.Tolerances Unless Dimension = ±0.1mm

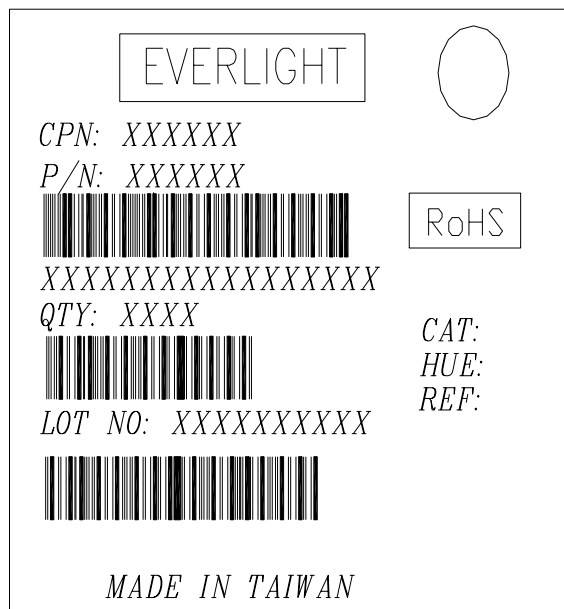
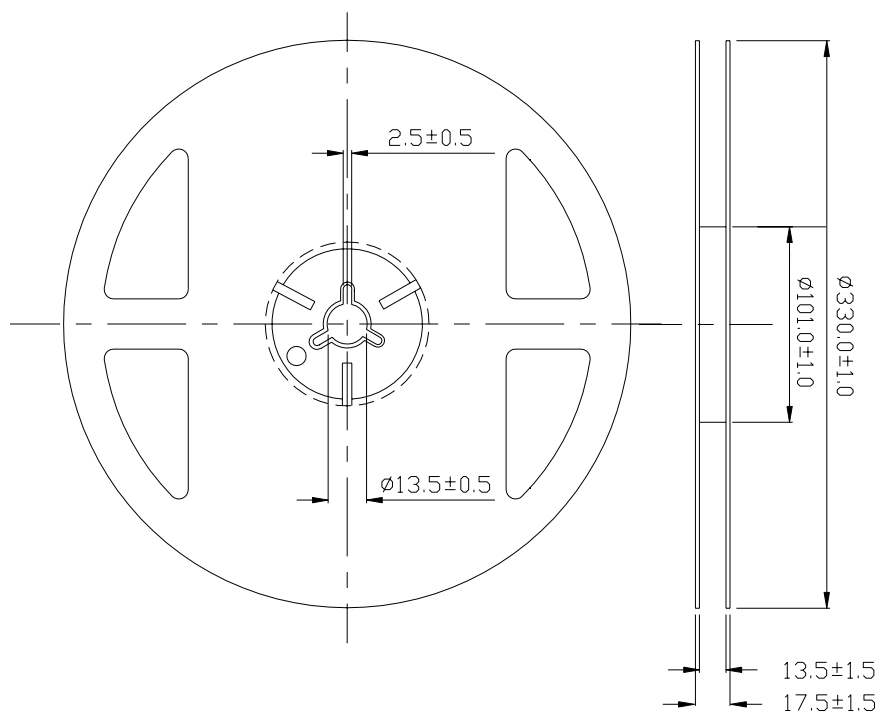
67-21BSURC/S530-XX/TR8
Absolute Maximum Ratings ($T_a=25^\circ\text{C}$)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	25	mA
Operating Temperature	T_{opr}	-40 ~ +85	
Storage Temperature	T_{stg}	-40 ~ +100	
Electrostatic Discharge (HBM)	ESD	2000	V
Power Dissipation	P_d	60	mW
Peak Forward Current(Duty 1/10 @ 1KHz)	I_{FP}	60	mA
Soldering Temperature	T_{sol}	Reflow Soldering : 260 for 10 sec. Hand Soldering : 350 for 3 sec.	

Electronic Optical Characteristics ($T_a=25^\circ\text{C}$) :

Parameter	Symbol	Rank	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I_v	A3	110	185	-----	mcd	$I_F=20\text{mA}$
		A4	135	220	-----		
		A5	170	270	-----		
		A6	220	365	-----		
Viewing Angle	2 1/2	-----	-----	60	-----	deg	$I_F=20\text{mA}$
Peak Wavelength	λ_p	-----	-----	632	-----	nm	$I_F=20\text{mA}$
Dominant Wavelength	λ_d	-----	-----	624	-----	nm	$I_F=20\text{mA}$
Spectrum Radiation Bandwidth		-----	-----	20	-----	nm	$I_F=20\text{mA}$
Forward Voltage	V_F	-----	1.7	2.0	2.4	V	$I_F=20\text{mA}$
Reverse Current	I_R	-----	-----	-----	10	μA	$V_R=5\text{V}$

Typical Electro-Optical Characteristics Curves


Label explanation
CAT: Luminous Intensity Rank
HUE: Dom. Wavelength Rank
REF: Forward Voltage Rank

Reel Dimensions

Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260 ±5 Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100 15min 5 min L : -40 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100 5min 10 sec L : -10 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85 / 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use**1. Over-current-proof**

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

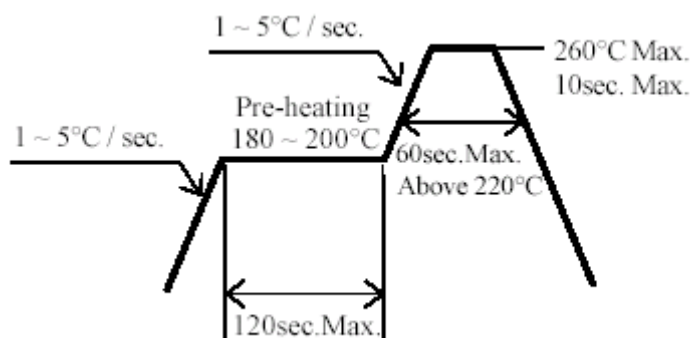
2.2 Before opening the package: The LEDs should be kept at 30 °C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less.

If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60 ± 5 °C for 24 hours.

3. Soldering Condition**3.1 Pb-free solder temperature profile**

3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

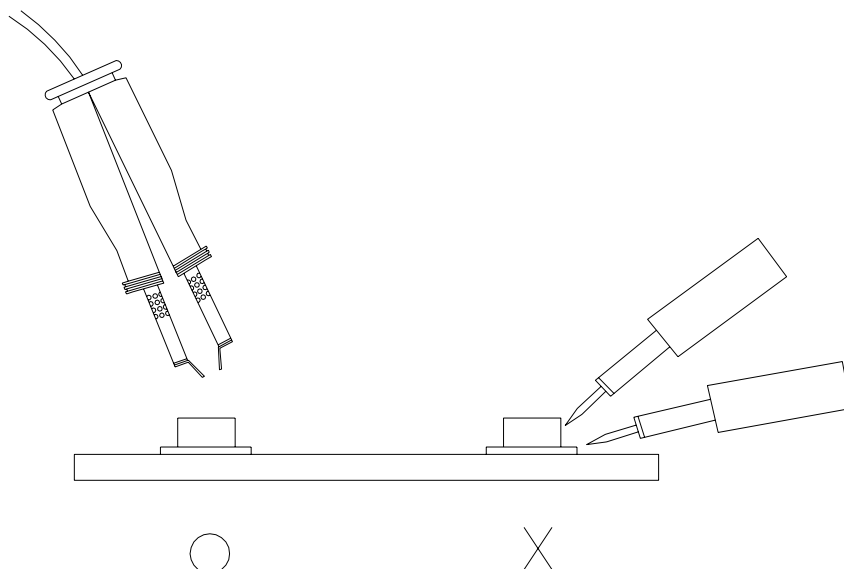
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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